Thermal technologies in food processing

Edited by Philip Richardson



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Notation

а	surface area	m^2
Α	surface area	m^2
Α	coefficient matrix	kg s ^{-1}
a, b	constants	
A_p	particle surface area	m^2
$Bi = hd/\lambda$	Biot number	
\overrightarrow{B}	magnetic flux density	
В	flux density	$ m VSm^{-2}$
С	capacity matrix	$J °C^{-1}$
С	concentration of bacteria in liquid food	number of
		bacteria m ⁻³
C_1, C_2	constants	
C_η	turbulence constant	
С	heat capacity (Chapter 6)	$J kg^{-1} °C^{-1}$
c, c_0	velocity of light, in vacuum (Chapter 10)	
c_a	specific moisture capacity of vapour phase	
C_P	specific heat capacity (constant pressure)	$J kg^{-1} K^{-1}$
Ď	electric flux density	$V S m^{-2}$
D	flux density	$ m VSm^{-2}$
D	decimal reduction time	min
$D_{\rm ref}$	reference decimal reduction time	min
$D_{\rm p}$	field penetration depth	m
$D_{\rm e}$	diffusion coefficient	$m^2 s^{-1}$
$\stackrel{d}{\longrightarrow}$	diameter	m
É	electric field	
Ε	electric field strength	$\mathrm{V}\mathrm{m}^{-1}$

F	F-value: integrated lethality (Chapter 7)	min
\hat{F}	volumetric average	$\mathrm{s}\mathrm{m}^{-3}$
f	thermal load vector	W
f	frequency	GHz
f_i	volumetric body force	$N m^{-3}$
F_i	Cartesian component of particle force	Ν
Fo	Fourier number	
G = SR/V - 1	shape factor of the container	
g	acceleration due to gravity (Chapter 7)	ms^{-2}
g, h	constant (Chapter 10)	
H	static enthalpy (Chapter 6)	$J \text{ kg}^{-1}$
H	specific enthalpy (Chapter 7)	$J m^{-3}$
\overrightarrow{H}	magnetic field (Chapter 10)	
Н	magnetic field (Chapter 7)	$A m^{-1}$
h	surface heat transfer coefficient (Chapter 6)	$W m^{-2} °C^{-1}$
h	convective heat transfer coefficient	$W m^{-2} K^{-1}$
	(Chapter 7)	
h	Planck's constant	
h _{evap}	evaporation heat density	
h_i	enthalpy of phase <i>i</i>	
I_i	mass sink or source density of phase i	
i	imaginary unit	
\overrightarrow{j}	electric current density	
Κ	turbulent kinetic energy	$m^{2} s^{-2}$
K	stiffness matrix	$W \circ C^{-1}$
k	electrical conductivity	$\mathrm{S}\mathrm{m}^{-1}$
k	thermal conductivity (Chapter 7)	$W m^{-1} °C^{-1}$
\underline{k}	Boltzmann's constant (Chapter 10)	
k	wave vector	
k _t	reaction rate constant at temperature T	s^{-1}
L	characteristic length	m .
М	molecular weight (Chapter 6)	kg mol ^{-1}
M, M_l	moisture content, liquid moisture content	
	(Chapter 10)	
m, n, o, p. q, r	exponents (Chapter 6)	
m	constant (Chapter 10)	
Ν	shape function	
n	constant	
n _i	concentration of ion <i>i</i>	
n_{\perp}	outward normal to surface	
P	polarisation	
р	pressure	Ра
Q	power dissipated per unit volume	$W m^{-3}$
	(Chapter 7)	

Q	volumetric heat generation (Chapter 6)	$W m^{-3}$
\overline{Q}	rate of heat (Chapter 11)	$J s^{-1}$
Q(R)	radiant flux emitted per unit area unit	
	increment of wavelength	$\mathrm{W} \mathrm{m}^{-2} \eta \mathrm{m}$
Q	source term vector	units s^{-1}
Q_{em}	electromagnetic heat production density	
q_R	radiative power flux density	
R	universal gas constant (Chapter 6)	$\mathrm{J} \mathrm{mol}^{-1} \mathrm{K}^{-1}$
R	smallest characteristic dimension of a	m
	geometry (Chapter 7)	
r	residual (Chapter 6)	
r	radial position of a can (Chapter 7)	m
r	reflected waves (Chapter 11)	
$\Re(x)$	real part of x	
S	heat transfer surface	m^2
S_{ϕ}	source of quantity ϕ	units m^{-3} s $^{-1}$
T	temperature	°C or K
$T_{\rm ref}$	reference temperature	Κ
T _m	temperature of the heating medium	Κ
t	time (Chapters 6, 7, 10)	s
t	transmitted waves (Chapter 11)	
U	velocity vector	${ m m~s^{-1}}$
u	nodal temperature vector	
и	velocity in the vertical direction	ms^{-1}
u_j	Cartesian velocity component	$m s^{-1}$
V	volume	m ³
V	voltage (Chapter 7)	V
v	velocity in the radial direction	ms^{-1}
\overrightarrow{x}	local vector	
<i>x_i, x, y, z</i>	Cartesian coordinate (Chapter 6)	m
<i>x</i> , <i>z</i>	distance (Chapter 7)	m
Ζ	Z-value: slope of the lethality or cooking curve	Κ
Z_{q}	quality factor	Κ
Zi	valence of ion <i>i</i>	
Greek symbols		
Ω	object domain	
Γ	boundary of object	
Γ	diffusivity of quantity ϕ	$kg m^{-1} s^{-1}$
α	absorbed waves	
α_M	mass diffusivity	
α_p	pressure diffusivity	
$\alpha = \lambda / \rho \ c_p$	thermal diffusivity	$m^2 s^{-1}$
$\chi = \epsilon - 1$	dielectric susceptibility	
δ_E	electric field attenuation length	

δ_p	pressure gradient coefficient/power	
*	attenuation length	
δ_T	thermal gradient coefficient	
ϵ	turbulent energy dissipation rate (Chapter 6)	$m^{2} s^{-3}$
ϵ	emissivity (Chapter 11)	
ϵ	permittivity (Chapter 7)	Fm^{-1}
$\epsilon = \epsilon' - i\epsilon''$	relative permittivity (Chapter 10)	
ϵ_c	convergence error	
ϵ'	dielectric constant (Chapter 7)	
ϵ''	dielectric loss factor (Chapter 7)	
ϵ_0	dielectric constant of vacuum	
ϵ_V	ratio of vapour flow to total moisture flow	
ζ	ratio of vapour diffusion to total moisture	
	diffusion (Chapter 6)	
ζ	dimensionless axial length (Chapter 7)	
η	dynamic viscosity	$kg m^{-1} s^{-1}$
$\theta = T/T_{\rm ref}$	dimensionless temperature (Chapter 7)	
θ	dimensionless temperature	
κ	damping constant	
λ	wavelength (Chapter 10)	
λ	thermal conductivity (Chapter 7)	$W m^{-1} K^{-1}$
μ	relative permeability (Chapter 10)	
μ	apparent viscosity (Chapter 7)	Pa s
μ_0	permeability of vacuum	
μ_i	mobility of ion <i>i</i>	
ϕ	transported quantity per unit mass	units kg^{-1}
ρ	density (charge, mass)	kg m ^{-3}
σ	Stefan-Boltzmann constant (Chapters 6 and 11)	$W m^{-2} K^{-4}$
σ	conductivity (Chapter 10)	
σ	electrical conductivity (Chapter 7)	$W m^{-1} K^{-1}$
$\sigma_{ m S}$	electrical conductivity (solid)	$W m^{-1} K^{-1}$
$\sigma_{ m L}$	electrical conductivity (liquid)	$W m^{-1} K^{-1}$
$\sigma_{ m e}$	electrical conductivity (effective)	$W m^{-1} K^{-1}$
ω	circular frequency	
C. h. a suring to		
Subscripts	initial and dition	

0	initial condition
∞	ambient condition